TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

TC74VHC9541P,TC74VHC9541FT,TC74VHC9541FK

Octal Universal Schmitt Buffer with 3-State Outputs

The TC74VHC9541 is an ultra-high-speed octal Schmitt buffer fabricated using silicon-gate CMOS technology. The TC74VHC9541 combines low power consumption of CMOS with Schottky TTL speeds.

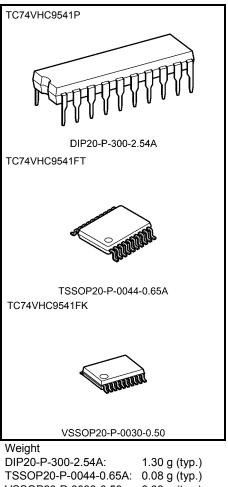
The outputs can be put in the high-impedance state by placing a logic HIGH on the Enable ($\overline{\mathbf{G}}$) input. The CONT input determines the logical inversion of data. A logic LOW on the CONT input configures the TC74VHC9541 as an inverter; a logic HIGH on the CONT input configures the TC74VHC9541 as a buffer.

All the inputs have hysteresis between the positive-going and negative-going thresholds. Thus the TC74VHC9541 is capable of squaring up transitions of slowly changing input signals and provides an improved noise immunity.

Additionally, all the inputs have a newly developed protection circuit without a diode returned to V_{CC}. This enables the inputs to be tolerant of up to 5 volts even when power supply is down. The input power-down protection capability makes the TC74VHC9541 ideal for a wide range of applications, such as interfacing between different voltages, voltage translation from 5 V to 3 V and battery back-up circuits.

Features

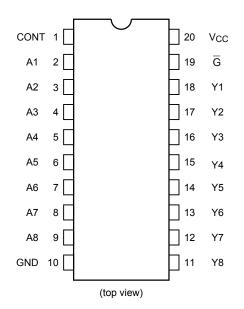
- High speed: $t_{pd} = 5.0 \text{ ns} (typ.) (V_{CC} = 5 \text{ V})$
- Low supply current: $I_{CC} = 4 \mu A (max) (Ta = 25^{\circ}C)$
- High noise immunity: V_{NIH} = V_{NIL} = 28% V_{CC} (min)
- All inputs are provided with power-down protection.
- Symmetrical rise and fall delays: $t_{pLH} \approx t_{pHL}$
- Wide operating voltage range: VCC (opr) = 2 to 5.5 V
- Pin-compatible with TC74VHC540 and TC74VHC541

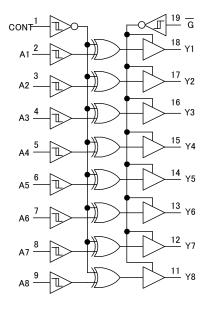


VSSOP20-P-0030-0.50: 0.03 g (typ.)

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Pin Assignment





Truth Table

	Inputs	Outputs			
G	CONT	An	Yn		
Н	Х	Х	Z		
L	L	L	Н		
L	L	Н	L		
L	Н	L	L		
L	Н	Н	Н		

X: Don't care

Z: High impedance

Absolute Maximum Ratings (Note)

Characteristics	Symbol	Rating	Unit
Supply voltage range	V _{CC}	-0.5 to 7.0	V
DC input voltage	V _{IN}	-0.5 to 7.0	V
DC output voltage	V _{OUT}	-0.5 to V _{CC} + 0.5	V
Input diode current	I _{IK}	-20	mA
Output diode current	I _{OK}	±20	mA
DC output current	IOUT	±25	mA
DC V _{CC} /ground current	ICC	±75	mA
Power dissipation	PD	500 (DIP) (Note 2)/180(TSSOP/VSSOP)	mW
Storage temperature	T _{stg}	−65 to 150	°C

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 2: 500 mW in the range of Ta = -40 to 65° C. From Ta = 65 to 85° C a derating factor of -10 mW/°C shall be applied until 300 mW.

Operating Ranges (Note)

Characteristics	Symbol	Rating	Unit
Supply voltage	V _{CC}	2.0 to 5.5	V
Input voltage	V _{IN}	0 to 5.5	V
Output voltage	V _{OUT}	0 to V _{CC}	V
Operating temperature	T _{opr}	-40 to 85	°C

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either V_{CC} or GND.

Electrical Characteristics

DC Characteristics

Characteristics	Symbol	Test Condition			Ta = 25°C			Ta = −40~85°C		Unit
Sharaclenslics Symbol				$V_{CC}(V)$	Min	Тур	Max	Min	Max	Unit
		_		3.0	_	—	2.20	—	2.20	
Positive threshold voltage	VP			4.5	-	_	3.15	_	3.15	V
C C				5.5	-	_	3.85	_	3.85	
		_		3.0	0.90	—		0.90	—	v
Negative threshold voltage	V _N			4.5	1.35	—		1.35	-	
C C				5.5	1.65	—	—	1.65	—	
		_		3.0	0.30	_	1.20	0.30	1.20	v
Hysteresis voltage	V _H			4.5	0.40	_	1.40	0.40	1.40	
				5.5	0.50	_	1.60	0.50	1.60	
	Vон	VIN = VIH or VIL	I _{OH} = -50 μA	2.0	1.9	2.0		1.9	_	V
				3.0	2.9	3.0		2.9	_	
High-level output voltage				4.5	4.4	4.5	_	4.4	_	
5			I _{OH} = −4 mA	3.0	2.58	—		2.48	_	
			I _{OH} = −8 mA	4.5	3.94	_		3.80	_	
	V _{OL}	V _{IN} = V _{IH} or V _{IL}	l _{OL} = 50 μA	2.0	-	0.0	0.1	_	0.1	V
				3.0		0.0	0.1	_	0.1	
Low-level output voltage				4.5		0.0	0.1	—	0.1	
			I _{OL} = 4 mA	3.0	_	_	0.36	_	0.44	
			I _{OL} = 8 mA	4.5		_	0.36	_	0.44	
3-state output off-state current	I _{OZ}	V _{IN} = V _{IH} or V _{IL} V _{OUT} = V _{CC} or GND		5.5	_	_	±0.25	_	±2.50	μA
Input leakage current	I _{IN}	V _{IN} = 5.5 V or GND		0 to 5.5		—	±0.1	—	±1.0	μA
Quiescent supply current	Icc	V _{IN} = V _{CC} or GND		5.5	_	_	4.0	_	40.0	μA

AC Characteristics (input: tr = tf = 3 ns)

Characteristics	Symbol	Test Condition		Ta = 25°C			Ta = −40 to 85°C		Unit	
	Cymbol		V _{CC} (V)	C _L (pF)	Min	Тур.	Max	Min	Max	Onit
	t _{pLH}	_	3.3 ± 0.3	15	_	6.0	8.0	1.0	10.0	- ns
Propagation delay time				50	_	9.0	12.5	1.0	15.0	
(An-Yn)	t _{pHL}		5.0 ± 0.5	15	-	5.0	5.5	1.0	7.0	
				50	_	7.0	8.5	1.0	10.0	
			3.3 ± 0.3	15	١	8.5	11.5	1.0	13.5	ns
Propagation delay time	t _{pLH}			50	I	13.0	17.0	1.0	20.5	
(CONT-Yn)	t _{pHL}	_	5.0 ± 0.5	15	I	6.5	8.0	1.0	9.5	
				50	-	10.5	12.5	1.0	15.0	
	t _{pZL} t _{pZH}	R _L = 1 kΩ	3.3 ± 0.3	15		6.0	8.0	1.0	9.5	- ns
3-state output enable				50	_	10.5	13.5	1.0	16.5	
time			5.0 ± 0.5	15	—	4.5	5.5	1.0	6.5	
				50	_	9.0	10.5	1.0	12.5	
3-state output disable	t _{pLZ}	R _L = 1 kΩ	3.3 ± 0.3	50	—	12.5	13.5	1.0	16.0	ns
time	t _{pHZ}		5.0 ± 0.5	50	_	9.0	9.5	1.0	11.0	115
Output to output skew	t _{osHL}	(Note 1)	3.3 ± 0.3	50	_	—	1.5	_	1.5	ns
	t _{osLH}	(NOLE T)	5.0 ± 0.5	50	_	_	1.0	_	1.0	115
Input capacitance	C _{IN}		_		-	4	10	-	10	pF
Output capacitance	C _{OUT}		_		_	6	-	-	_	pF
Power dissipation capacitance (Note 2)	C _{PD}	$f_{IN} = 1 \text{ MHz}$			_	11	_	_	_	pF

Note 1: Parameter guaranteed by design.

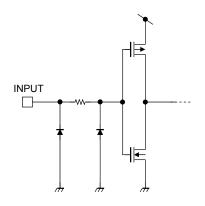
 $t_{\text{OSLH}} = |t_{\text{pLHm}} - t_{\text{pLHn}}|, t_{\text{OSHL}} = |t_{\text{pHLm}} - t_{\text{pHLn}}|$

Note 2: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation:

 $I_{CC (opr)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC} / 8 (per bit)$

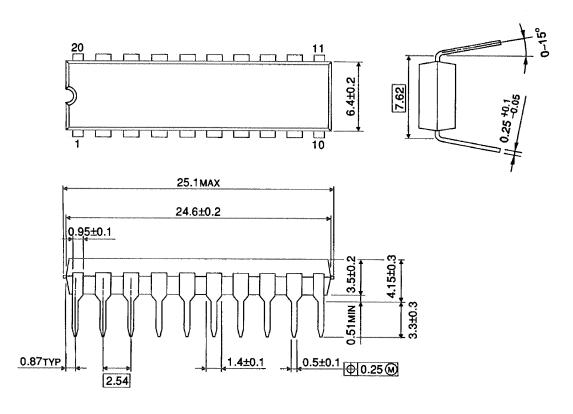
Input Equivalent Circuit



Package Dimensions

DIP20-P-300-2.54A

Unit : mm



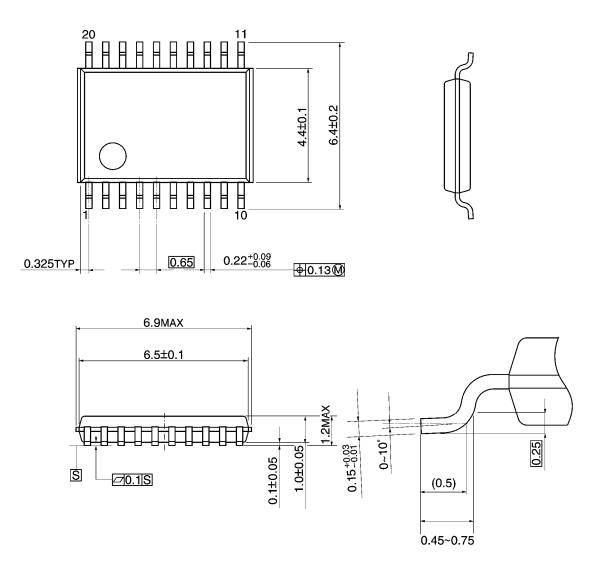
Weight: 1.30 g (typ.)

7

Package Dimensions

TSSOP20-P-0044-0.65A

Unit: mm



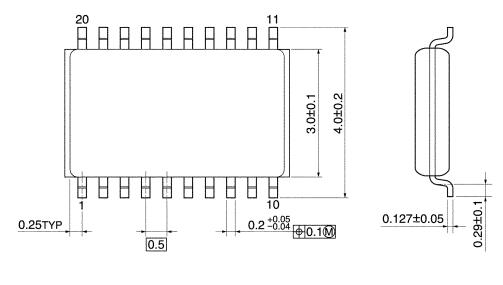
Weight: 0.08 g (typ.)

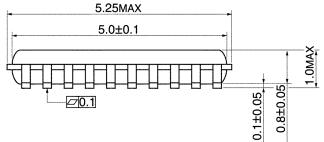
TOSHIBA

Package Dimensions

VSSOP20-P-0030-0.50

Unit: mm





Weight: 0.03 g (typ.)

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20070701-EN GENERAL

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